

GaAs INTEGRATED CIRCUIT

μ PG2181T5R

HIGH POWER DP4T SWITCH FOR WIMAX

DESCRIPTION

The μPG2181T5R is a GaAs MMIC high power DP4T switch which was developed for WiMAX.

This device can operate from 2.3 to 3.8 GHz, with low insertion loss and high isolation.

This device is housed in a 20-pin plastic RQFN (Rectangle Quad Flat Non-leaded) package, and is suitable for high-density surface mounting.

FEATURES

Supply voltage : V_{DD} = 2.8 to 3.2 V (3.0 V TYP.)
 Control voltage : V_{cont (H)} = 1.5 to V_{DD} (V_{DD} TYP.)
 : V_{cont (L)} = 0 to 0.2 V (0 V TYP.)

Low insertion loss
 : Lins1 = 0.8 dB TYP. @ f = 2.3 to 2.7 GHz, VDD = 3.0 V, Vcont (H) = 3.0 V, Vcont (L) = 0 V

: Lins2 = 1.0 dB TYP. @ f = 3.3 to 3.8 GHz, V_{DD} = 3.0 V, $V_{cont\,(H)}$ = 3.0 V, $V_{cont\,(L)}$ = 0 V

: ISL2 = 24 dB TYP. @ f = 3.3 to 3.8 GHz, Tx to Rx, V_{DD} = 3.0 V, V_{cont} (H) = 3.0 V, V_{cont} (L) = 0 V

: ISL3 = 25 dB TYP. @ f = 2.3 to 2.7 GHz, Tx to ANT, V_{DD} = 3.0 V, $V_{cont(H)}$ = 3.0 V, $V_{cont(L)}$ = 0 V : ISL4 = 21 dB TYP. @ f = 3.3 to 3.8 GHz, Tx to ANT, V_{DD} = 3.0 V, $V_{cont(H)}$ = 3.0 V, $V_{cont(L)}$ = 0 V

: ISL5 = 25 dB TYP. @ f = 2.3 to 2.7 GHz, Rx to ANT, V_{DD} = 3.0 V, $V_{cont}(H)$ = 3.0 V, $V_{cont}(L)$ = 0 V

: ISL6 = 22 dB TYP. @ f = 3.3 to 3.8 GHz, Rx to ANT, VDD = 3.0 V, Vcont (H) = 3.0 V, Vcont (L) = 0 V

• Power handling : $P_{in (1 dB)} = +40.0 dBm TYP$. @ f = 2.5/3.5 GHz, Tx to ANT, $V_{DD} = 3.0 V$, $V_{cont(H)} = 3.0 V$, $V_{cont(L)} = 0 V$

: Pin (1 dB) = +35.0 dBm TYP. @ f = 2.5/3.5 GHz, Rx to ANT, VDD = 3.0 V, V $_{cont}$ (H) = 3.0 V, V $_{cont}$ (L) = 0 V

High-density surface mounting: 20-pin plastic RQFN package (2.5 x 3.5 x 0.6 mm)

APPLICATION

Antenna switch for WiMAX CPE (<u>Customer Premise Equipment</u>)

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPG2181T5R-E2	μPG2181T5R-E2-A	20-pin plastic RQFN (Pb-Free)	G2181	Embossed tape 8 mm wide Pin 1, 6 face the perforation side of the tape Qty 3 kpcs/reel

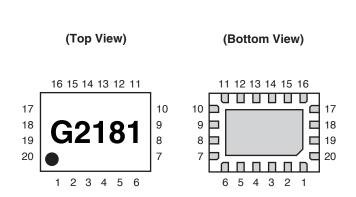
Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: µPG2181T5R-A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

PIN CONNECTIONS



Pin No.	Pin Name	Pin No.	Pin Name
1	GND	11	GND
2	GND	12	ANT1
3	Rx	13	GND
4	GND	14	Tx
5	ANT4	15	GND
6	GND	16	GND
7	ANT3	17	V_{DD}
8	GND	18	V _{cont} 2
9	GND	19	Vcont1
10	ANT2	20	V _{cont} 0

Remark Exposed pad : GND

TRUTH TABLE

CONTROL VOLTAGE			ON PATH								
				Tx			Rx				
V _{DD}	V _{cont} 0	Vcont1	V _{cont} 2	ANT1	ANT2	ANT3	ANT4	ANT1	ANT2	ANT3	ANT4
High	Low	Low	Low	ON	OFF						
High	High	Low	Low	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF
High	Low	High	Low	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF
High	High	High	Low	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF
High	Low	Low	High	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF
High	High	Low	High	OFF	OFF	OFF	OFF	OFF	ON	OFF	OFF
High	Low	High	High	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF
High	High	High	High	OFF	ON						

ABSOLUTE MAXIMUM RATINGS (Ta = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V _{DD}	4.2	V
Switch Control Voltage	Vcont	4.2	V
Input Power-Tx (ON Port)	P _{in-Tx}	+41	dBm
Input Power-Rx (ON Port)	P _{in-Rx}	+36	dBm
Input Power-Tx (OFF Port)	Pin-Tx (OFF)	+25	dBm
Input Power-Rx (OFF Port)	Pin-Rx (OFF)	+25	dBm
Power Dissipation	PD	800	mW
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	Tstg	-55 to +150	°C

RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f _{opt} 1	2.3	ı	2.7	GHz
	f _{opt} 2	3.3	-	3.8	GHz
Supply Voltage	V _{DD}	2.8	3.0	3.2	V
Switch Control Voltage (H)	V _{cont (H)}	1.5	V _{DD}	V _{DD}	V
Switch Control Voltage (L)	V _{cont (L)}	0	0	0.2	V

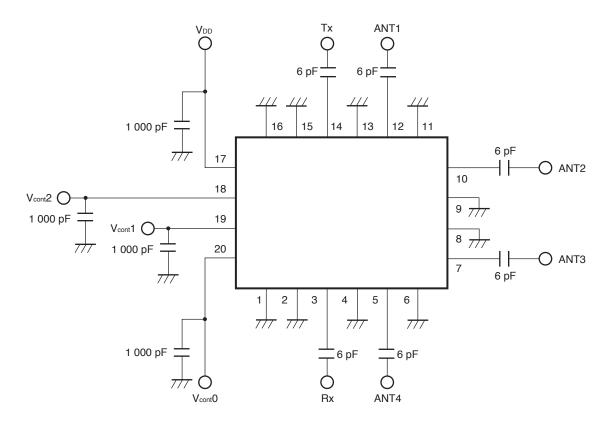
ELECTRICAL CHARACTERISTICS

(TA = +25°C, VDD = 3.0 V, Vcont (H) = 3.0 V, Vcont (L) = 0 V, DC blocking capacitors = 6 pF, Z0 = 50 Ω , unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	Lins1	f = 2.3 to 2.7 GHz, Tx to ANT1/2/3/4	-	0.80	1.05	dB
Insertion Loss 2	Lins2	f = 3.3 to 3.8 GHz, Tx to ANT1/2/3/4	-	1.00	1.30	dB
Insertion Loss 3	Lins3	f = 2.3 to 2.7 GHz, Rx to ANT1/2/3/4	-	0.80	1.05	dB
Insertion Loss 4	Lins4	f = 3.3 to 3.8 GHz, Rx to ANT1/2/3/4	-	1.00	1.30	dB
Isolation 1	ISL1	f = 2.3 to 2.7 GHz, Tx to Rx	25	28	-	dB
Isolation 2	ISL2	f = 3.3 to 3.8 GHz, Tx to Rx	21	24	-	dB
Isolation 3	ISL3	f = 2.3 to 2.7 GHz, Tx to ANT1/2/3/4	22	25	-	dB
Isolation 4	ISL4	f = 3.3 to 3.8 GHz, Tx to ANT1/2/3/4	18	21	-	dB
Isolation 5	ISL5	f = 2.3 to 2.7 GHz, Rx to ANT1/2/3/4	22	25	-	dB
Isolation 6	ISL6	f = 3.3 to 3.8 GHz, Rx to ANT1/2/3/4	19	22	-	dB
On Port Return Loss 1	RLin1	f = 2.3 to 2.7 GHz, All Port	-	15	-	dB
On Port Return Loss 2	RLin2	f = 3.3 to 3.8 GHz, All Port	-	15	-	dB
Unused Port Return Loss 1	URL1	f = 2.3 to 2.7 GHz, Tx/Rx Port	_	13	_	dB
Unused Port Return Loss 2	URL2	f = 3.3 to 3.8 GHz, Tx/Rx Port	-	13	-	dB
1 dB Loss Compression	Pin (1 dB)	f = 2.5 GHz, Tx to ANT1/2/3/4	-	+40.0	-	dBm
Input Power Note		f = 3.5 GHz, Tx to ANT1/2/3/4	_	+40.0	_	dBm
		f = 2.5 GHz, Rx to ANT1/2/3/4	-	+35.0	-	dBm
		f = 3.5 GHz, Rx to ANT1/2/3/4	-	+35.0	-	dBm
Output 3rd Order Intercept Point	OIP ₃ 1	f = 2.5 GHz, Tx to ANT1/2/3/4	-	+63.0	-	dBm
	OIP ₃ 2	f = 2.5 GHz, Rx to ANT1/2/3/4	-	+57.0	-	dBm
Supply Current	IDD	RF None	-	600	1 100	μΑ
Switch Control Current	Icont	RF None	-	1	2	μΑ
Switch Control Speed	tsw	50% CTL to 90/10% RF	-	250	-	ns

Note Pin (1 dB) is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

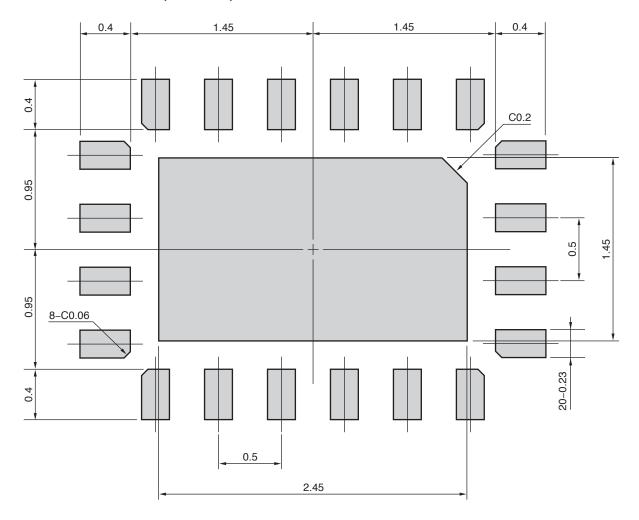
EVALUATION CIRCUIT



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

MOUNTING PAD DIMENSIONS

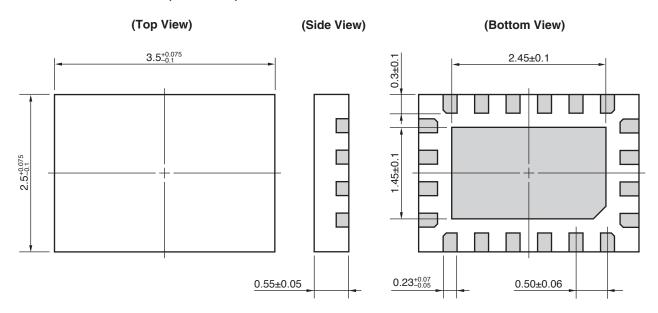
20-PIN PLASTIC RQFN (UNIT: mm)



Remark The mounting pad layouts in this document are for reference only.

PACKAGE DIMENSIONS

20-PIN PLASTIC RQFN (UNIT: mm)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

- The information in this document is current as of October, 2007. The information is subject to change without notice. For actual design-in, refer to the latest publications of NEC Electronics data sheets or data books, etc., for the most up-to-date specifications of NEC Electronics products. Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.
- No part of this document may be copied or reproduced in any form or by any means without the prior
 written consent of NEC Electronics. NEC Electronics assumes no responsibility for any errors that may
 appear in this document.
- NEC Electronics does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from the use of NEC Electronics products listed in this document or any other liability arising from the use of such products. No license, express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Electronics or others.
- Descriptions of circuits, software and other related information in this document are provided for illustrative
 purposes in semiconductor product operation and application examples. The incorporation of these
 circuits, software and information in the design of a customer's equipment shall be done under the full
 responsibility of the customer. NEC Electronics assumes no responsibility for any losses incurred by
 customers or third parties arising from the use of these circuits, software and information.
- While NEC Electronics endeavors to enhance the quality, reliability and safety of NEC Electronics products, customers agree and acknowledge that the possibility of defects thereof cannot be eliminated entirely. To minimize risks of damage to property or injury (including death) to persons arising from defects in NEC Electronics products, customers must incorporate sufficient safety measures in their design, such as redundancy, fire-containment and anti-failure features.
- NEC Electronics products are classified into the following three quality grades: "Standard", "Special" and "Specific".

The "Specific" quality grade applies only to NEC Electronics products developed based on a customer-designated "quality assurance program" for a specific application. The recommended applications of an NEC Electronics product depend on its quality grade, as indicated below. Customers must check the quality grade of each NEC Electronics product before using it in a particular application.

- "Standard": Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
- "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support).
- "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

The quality grade of NEC Electronics products is "Standard" unless otherwise expressly specified in NEC Electronics data sheets or data books, etc. If customers wish to use NEC Electronics products in applications not intended by NEC Electronics, they must contact an NEC Electronics sales representative in advance to determine NEC Electronics' willingness to support a given application.

(Note)

- (1) "NEC Electronics" as used in this statement means NEC Electronics Corporation and also includes its majority-owned subsidiaries.
- (2) "NEC Electronics products" means any product developed or manufactured by or for NEC Electronics (as defined above).

M8E 02.11-1

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.



4590 Patrick Henry Drive Santa Clara, CA 95054-1817 Telephone: (408) 919-2500

Facsimile: (408) 988-0279

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The -AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)		on contained devices	
Lead (Pb)	< 1000 PPM	< 1000 PPM -A Not Detected		
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

Important Information and Disclaimer: Information provided by CEL on its website or in other communications concerting the substance content of its products represents knowledge and belief as of the date that it is provided. CEL bases its knowledge and belief on information provided by third parties and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. CEL has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. CEL and CEL suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

See CEL Terms and Conditions for additional clarification of warranties and liability.